

Product Summary

V_{RRM} (V)	I_O (A)	V_F MAX(V) @+25°C	I_R MAX (mA) @+25°C
60	30	0.63	0.33

Description and Applications


This Super Barrier Rectifier (SBR) diode has been designed to meet the stringent requirements of Automotive Applications. It is ideally suited to use as :

- Polarity Protection Diode
- Re-circulating Diode
- Switching Diode

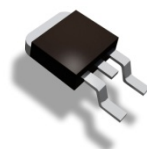
Features and Benefits

- 100% Avalanche Tested
- Patented SBR technology provides a superior avalanche capability than schottky diodes ensuring more rugged and reliable end applications.
- Reduced ultra-low forward voltage drop (V_F); better efficiency and cooler operation.
- Reduced high temperature reverse leakage; increased reliability against thermal runaway failure in high temperature operation
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

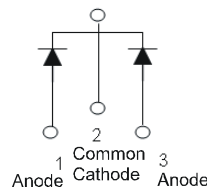
Mechanical Data

- Case: TO263 (D²PAK)
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 
- Polarity: See Below
- Weight: 1.6 grams (approximate)

TO263



Top View



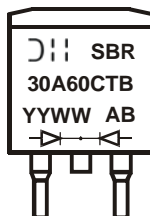
Package Pin-Out
Configuration

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SBR30A60CTBQ-13	Automotive	TO263	800/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>

Marking Information



SBR30A60CTB = Product Type Marking Code
 AB = Foundry and Assembly Code
 YYWW = Date Code Marking
 YY = Last two digits of year (ex: 13 = 2013)
 WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	60	V
Average Rectified Output Current	I _O	30	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	180	A
Repetitive Peak Avalanche Power (1μs, +25°C)	P _{ARM}	6000	W
Non-Repetitive Avalanche Energy (T _J = +25°C, I _{AS} = 12A, L = 10mH)	E _{AS}	600	mJ

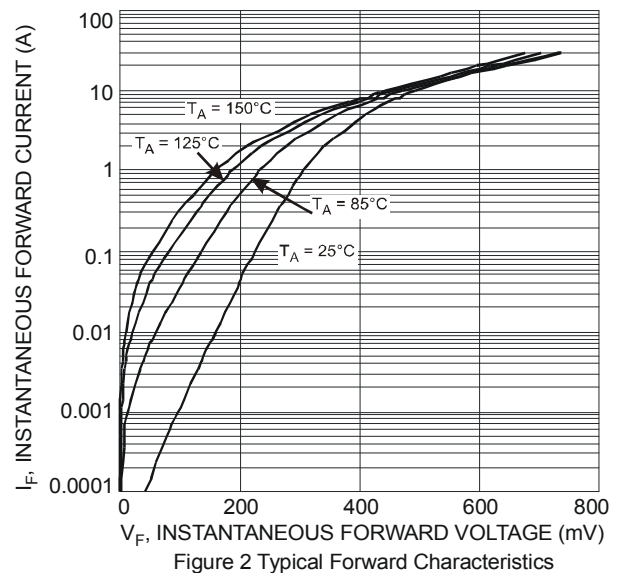
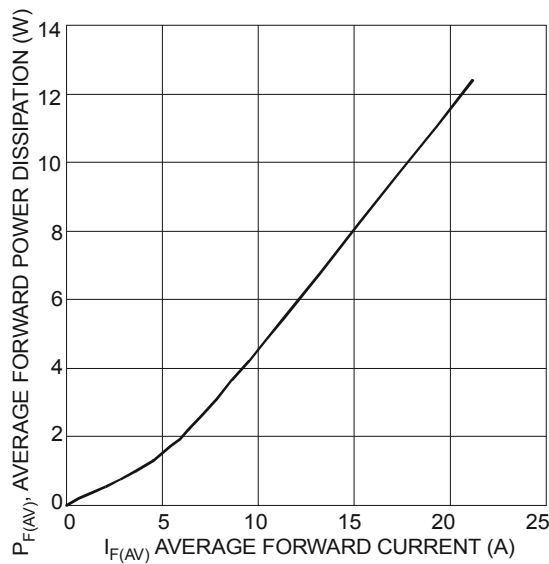
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5)	R _{θJC}	9	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	-	0.57 0.55	0.63 -	V	I _F = 15.0A, T _J = +25°C I _F = 15.0A, T _J = +125°C
Leakage Current (Note 6)	I _R	-	0.11 40	0.33 -	mA	V _R = 60V, T _J = +25°C V _R = 60V, T _J = +125°C

- Notes: 5. Device mounted on Polyimide substrate, 125mm² copper pad, double-sided, PC boards.
 6. Short duration pulse test used to minimize self-heating effect.



7. Device mounted on Polyimide substrate, 125mm² copper pad, double-sided, PC boards.

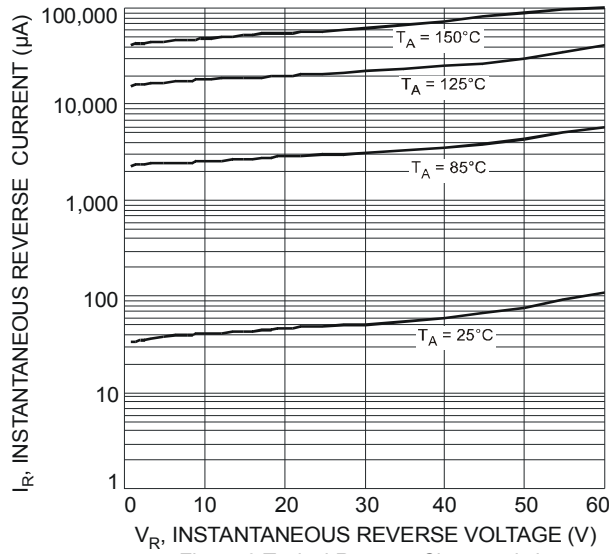


Figure 3 Typical Reverse Characteristics

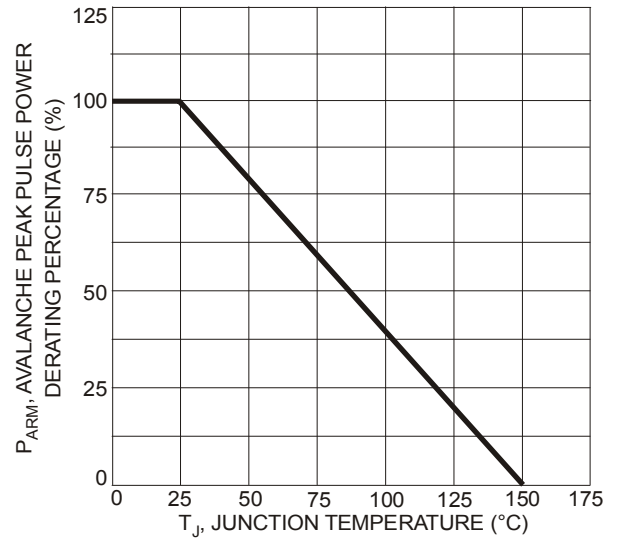


Figure 4 Pulse Derating Curve, Per Element

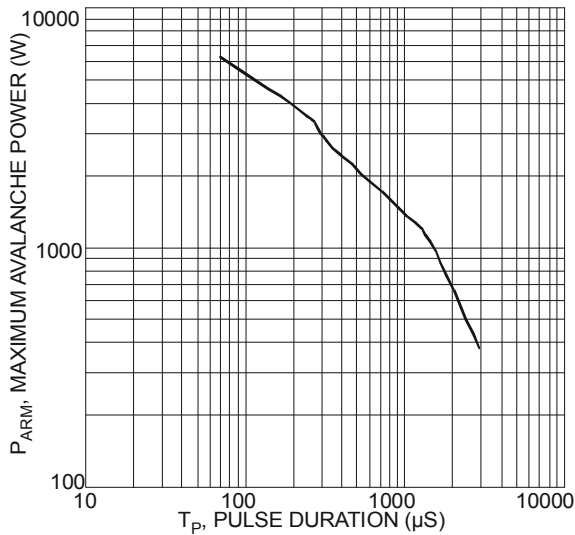


Figure 5 Maximum Avalanche Power Curve, Per Element

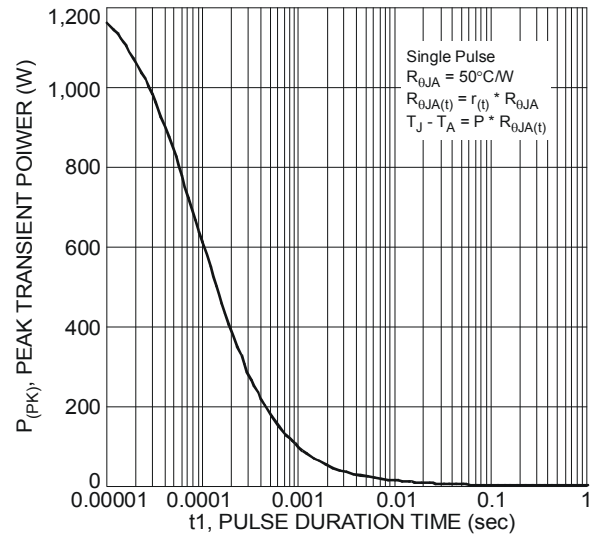


Figure 6 Single Pulse Maximum Power Dissipation

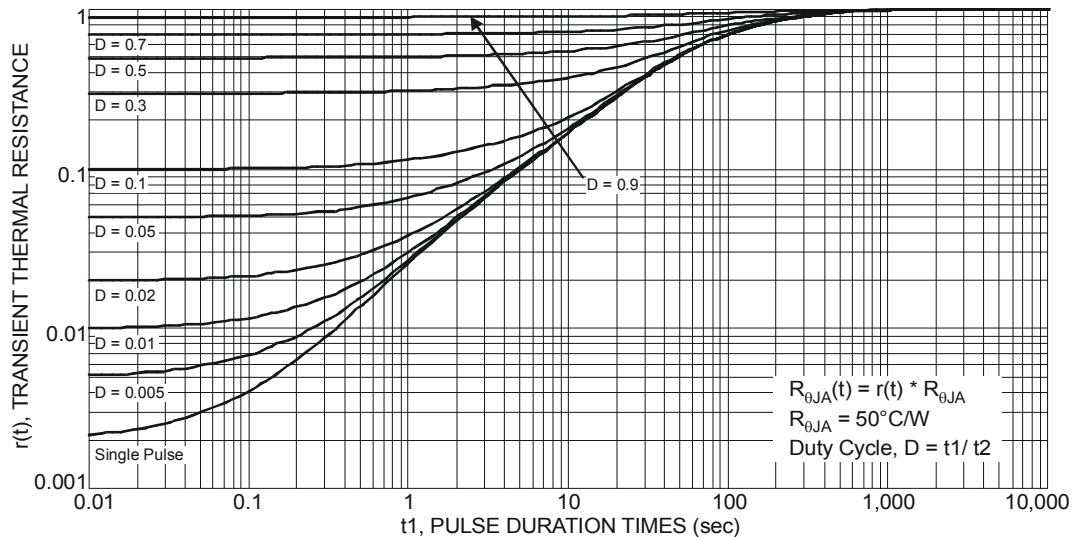
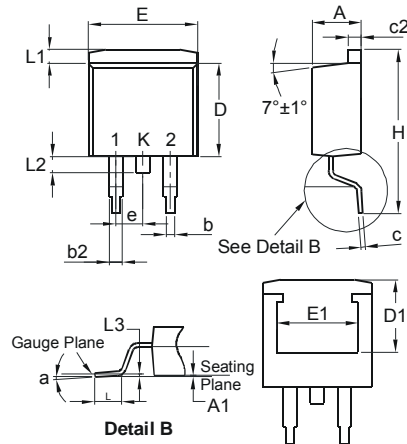


Figure 7 Transient Thermal Resistance

Package Outline Dimensions

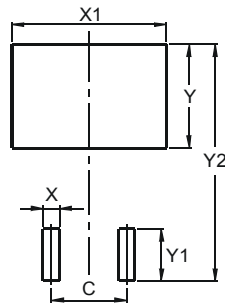
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



TO263		
Dim	Min	Max
A	4.07	4.82
A1	0.00	0.25
b	0.51	0.99
b2	1.15	1.77
c	0.356	0.73
c2	1.143	1.65
D	8.39	9.65
D1	6.55	—
E	9.66	10.66
E1	6.23	—
e	2.54 Typ	
H	14.61	15.87
L	1.78	2.79
L1	—	1.67
L2	—	1.77
a	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	5.08
X	1.10
X1	10.41
Y	3.50
Y1	7.01
Y2	15.99

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